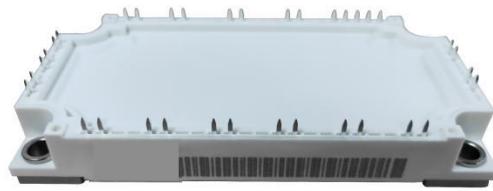


Electrical Features

- Trench/Fieldstop IGBT
- V_{CEsat} with positive Temperature Coefficient
- Low V_{CEsat}



Typical Applications

- Auxiliary inverters
- Motor drives
- Servo drives

Mechanical Features

- High power density
- Integrated NTC temperature sensor
- Copper base plate
- Solder contact technology
- Standard housing

IGBT , Inverter

Maximum Rated Values					
Symbol	Item	Conditions	Rating		Unit
IGBT					
V_{CES}	Collector- emitter voltage	$T_{vj}=25^{\circ}\text{C}$	1200		V
V_{GES}	Gate- emitter voltage	-	± 20		V
I_C	Collector current,DC	$T_c= 100^{\circ}\text{C}, T_{vj}= 175^{\circ}\text{C}$	50		A
I_{CRM}	Repetitive peak collector current	$t_p= 1\text{ms}$	100		A
P_{tot}	Total power dissipation	$T_c=25^{\circ}\text{C}, T_{vj}= 175^{\circ}\text{C}$	278		W
Characteristics Values					
Symbol	Item	Conditions	Values		Unit
IGBT			Min.	Typ.	Max.
I_{CES}	Collector-emitter cut-off current	$V_{CE}= 1200\text{V}, V_{GE}= 0\text{V}, T_{vj}= 25^{\circ}\text{C}$	-	-	1 mA
I_{GES}	Gate leakage current	$V_{CE}= 0\text{V}, V_{GE}= 20\text{V}, T_{vj}= 25^{\circ}\text{C}$	-	-	400 nA
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C= 1.5\text{mA}, V_{CE}= V_{GE}, T_{vj}= 25^{\circ}\text{C}$	5.2	5.72	6.5 V
V_{CEsat}	Collector-emitter saturation voltage	$I_C= 50\text{A}$ $V_{GE}= 15\text{V}$	$T_{vj}= 25^{\circ}\text{C}$	-	1.94 -
			$T_{vj}= 125^{\circ}\text{C}$	-	- -
			$T_{vj}= 150^{\circ}\text{C}$	-	- -
C_{ies}	Input capacitance	$V_{CE}= 25\text{V}, V_{GE}= 0\text{V}$ $f= 1\text{MHz}, T_{vj}= 25^{\circ}\text{C}$	-	3.535	-
C_{oes}	Output capacitance		-	0.231	-
C_{res}	Reverse transfer capacitance		-	0.119	-
Q_G	Gate charge	$V_{CC}= 600\text{V}, I_C= 50\text{A}$ $V_{GE}= -15\ldots +15\text{V}, T_{vj}= 25^{\circ}\text{C}$	-	0.201	-
R_g	Internal gate resistance	$T_{vj}= 25^{\circ}\text{C}$	-	4	Ω

$t_{d(on)}$	Turn-on delay time	$V_{CC}=600V$ $I_C=50A$ $V_{GE}=\pm 15V$ $R_{G(on)}=41\Omega$ $R_{G(off)}=41\Omega$	$T_{vj}=25^\circ C$	-	408	-	ns	
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
t_r	Rise time		$T_{vj}=25^\circ C$	-	324	-		
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
$t_{d(off)}$	Turn-off delay time		$T_{vj}=25^\circ C$	-	773	-		
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
t_f	Fall time		$T_{vj}=25^\circ C$	-	300	-		
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
E_{on}	Turn-on energy (per pulse)		$T_{vj}=25^\circ C$	-	24.4	-	mJ	
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
E_{off}	Turn-off energy (per pulse)		$T_{vj}=25^\circ C$	-	4.93	-		
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
SC data	Short-circuit current	$V_{CC}=600V, V_{GE}\leq 15V, T_{vj}=25^\circ C$ $V_{CES}\leq 1200V, t_p\leq 10\mu s$	-	350	-	-	A	
R_{thJC}	Thermal resistance, junction to case	Per IGBT	-	-	0.54	K/W		
R_{thCH}	Thermal resistance, case to heatsink	Per IGBT λ grease = 1W/(m·K)	-	0.135	-	K/W		
T_{vjop}	Temperature under switching conditions		-40		150	°C		

Diode , Inverter

Maximum Rated Values

Symbol	Item	Conditions	Rating	Unit
V_{RRM}	Repetitive peak reverse voltage	$T_{vj}=25^\circ C$	1200	V
I_F	Forward current,DC		50	A
I_{FRM}	Repetitive peak forward current	$t_p=1ms$	100	A
I^2t	I^2t -value	$V_R=0V, t_p=10ms, T_{vj}=25^\circ C$	1800	A^2s

Characteristic Values

V_F	Continuous forward voltage	$I_F=50A$ $V_{GE}=0V$	$T_{vj}=25^\circ C$	-	2.27	-	V	
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
I_{RM}	Peak reverse recovery current		$T_{vj}=25^\circ C$	-	8.8	-	A	
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
t_{rr}	Reverse recovery time	$V_R=600V$ $I_F=50A$ $V_{GE}=-15V$	$T_{vj}=25^\circ C$	-	382	-	ns	
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		
Q_r	Recovered charge		$T_{vj}=25^\circ C$	-	1.14	-	μC	
			$T_{vj}=125^\circ C$	-	-	-		
			$T_{vj}=150^\circ C$	-	-	-		

E _{rec}	Reverse recovery energy		T _{vj} =25°C	-	0.37	-	mJ
			T _{vj} =125°C	-	-	-	
			T _{vj} =150°C	-	-	-	
R _{thJC}	Thermal resistance, junction to case	per diode	-	-	0.81	K/W	
R _{thCH}	Thermal resistance, case to heatsink	per diode, $\lambda_{grease}=1\text{ W/(m} \cdot \text{K)}$	-	0.2	-	K/W	
T _{vjop}	Temperature under switching conditions		-40		150	°C	

Diode, Rectifier

Maximum Rated Values

Symbol	Item	Conditions	Rating		Unit
V _{RRM}	Repetitive peak reverse voltage	T _{vj} =25°C	1800		V
I _{FRMSM}	Maximum RMS forward current per chip	T _c =80°C	80		A
I _{RMSM}	Maximum RMS current at rectifier output	T _c =80°C	115		A
I _{FSM}	Surge forward current	t _p =10 ms, T _{vj} =25°C	600		A
I ² t	I ² t-value	V _R =0V, t _p =10ms, T _{vj} =25°C	1800		A ² s

Characteristic Values

Symbol	Item	Conditions	Values			Unit	
			Min.	Typ.	Max.		
V _F	Continuous forward voltage	I _F =50A V _{GE} =0V	T _{vj} =25°C	-	1.16	-	V
			T _{vj} =125°C	-	-	-	
			T _{vj} =150°C	-	-	-	
I _R	Reverse current	V _R =1800V	T _{vj} =25°C	-	-	10	uA
			T _{vj} =125°C	-	-	-	
			T _{vj} =150°C	-	-	-	
T _{vjop}	Temperature under switching conditions		-40		150	°C	

IGBT , Brake-Chopper

Maximum Rated Values

Symbol	Item	Conditions	Values		Unit
V _{CES}	Collector- emitter voltage	T _{vj} =25°C	1200		V
V _{GES}	Gate-emitter voltage	-	±20		V
I _C	Collector current,DC	T _c =100°C, T _{vj} =175°C	40		A
I _{CRM}	Repetitive peak collector current	t _p =1ms	80		A
P _{tot}	Total power dissipation	T _c =25°C, T _{vj} =175°C	250		W

Characteristic Values

Symbol	Item	Conditions	Values			Unit
			Min.	Typ.	Max.	
IGBT						
I _{CES}	Collector-emitter cut-off current	V _{CE} =1200V, V _{GE} =0V, T _{vj} =25°C	-	-	1	mA
I _{GES}	Gate leakage current	V _{CE} =0V, V _{GE} =20V, T _{vj} =25°C	-	-	400	nA
V _{GE(th)}	Gate-emitter threshold voltage	I _C =1.5mA, V _{CE} =V _{GE} , T _{vj} =25°C	5.2	5.5	6.5	V

V _{CESat}	Collector-emitter saturation voltage	I _C =40A V _{GE} =15V	T _{vj} =25°C	-	2.0	-	
			T _{vj} = 125°C	-	-	-	
			T _{vj} = 150°C	-	-	-	
C _{ies}	Input capacitance	V _{CE} =25V,V _{GE} =0V f=1MHz,T _{vj} =25°C	-	3.13	-	-	nF
C _{oes}	Output capacitance		-	0.17	-	-	
C _{res}	Reverse transfer capacitance		-	0.09	-	-	
Q _G	Gate charge	V _{CC} =600V,I _C =40A V _{GE} =- 15...+ 15V,T _{vj} =25°C	-	0.24	-	-	μC
R _g	Internal gate resistance	T _{vj} =25°C	-	-	-	-	Ω
t _{d(on)}	Turn-on delay time	V _{CC} =600V I _C =40A V _{GE} =±15V R _{G(on)} =41Ω R _{G(off)} =41Ω	T _{vj} =25°C	-	321	-	ns
t _r	Rise time		T _{vj} = 125°C	-	-	-	
t _{d(off)}	Turn-off delay time		T _{vj} = 150°C	-	-	-	
t _f	Fall time		T _{vj} =25°C	-	339	-	
E _{on}	Turn-on energy (per pulse)		T _{vj} = 125°C	-	-	-	
E _{off}	Turn-off energy (per pulse)		T _{vj} = 150°C	-	-	-	
SC data	Short-circuit current		T _{vj} =25°C	-	606	-	mJ
R _{thJC}	Thermal resistance,junction to case		T _{vj} = 125°C	-	-	-	
R _{thCH}	Thermalresistance,case to heatsink		T _{vj} = 150°C	-	-	-	
T _{vjop}	Temperature under switching conditions		T _{vj} =25°C	-	259	-	
			T _{vj} = 125°C	-	-	-	
			T _{vj} = 150°C	-	-	-	
			T _{vj} =25°C	-	14	-	
			T _{vj} = 125°C	-	-	-	
			T _{vj} = 150°C	-	-	-	
			T _{vj} =25°C	-	2.67	-	
			T _{vj} = 125°C	-	-	-	
			T _{vj} = 150°C	-	-	-	
SC data	Short-circuit current	V _{CC} =600V,V _{GE} ≤ 15V,T _{vj} =25°C V _{CES} ≤ 1200V,t _p ≤ 10μs	-	280	-	-	A
R _{thJC}	Thermal resistance,junction to case	Per IGBT	-	-	0.6	K/W	
R _{thCH}	Thermalresistance,case to heatsink	Per IGBT λgrease= 1W/(m·K)	-	-	-	-	K/W
T _{vjop}	Temperature under switching conditions		-40		150	°C	
Diode , Brake-Chopper							
Maximum Rated Values							
Symbol	Item	Conditions		Rating		Unit	
V _{RRM}	Repetitive peak reverse voltage	T _{vj} =25°C		1200		V	
I _F	Forward current,DC			15		A	
I _{FRM}	Repetitive peak forward current	t _p = 1ms		30		A	
I ² t	I ² t-value	V _R =0V,t _p = 10ms,T _{vj} =25°C		166		A ² s	
Characteristic Values							
V _F	Continuous forward voltage	I _F = 15A V _{GE} =0V	T _{vj} =25°C	-	1.97	-	V
			T _{vj} = 125°C	-	-	-	
			T _{vj} = 150°C	-	-	-	

I _{RM}	Peak reverse recovery current	V _R =600V I _F =40A V _{GE} =-15V R _{G(on)} =41Ω R _{G(off)} =41Ω	T _{vj} =25°C	-	7	-	A	
			T _{vj} = 125°C	-	-	-		
			T _{vj} = 150°C	-	-	-		
t _{rr}	Reverse recovery time		T _{vj} =25°C	-	667	-	ns	
			T _{vj} = 125°C	-	-	-		
			T _{vj} = 25°C	-	1.52	-		
Q _r	Recovered charge		T _{vj} = 125°C	-	-	-	μC	
			T _{vj} =25°C	-	0.48	-		
			T _{vj} = 125°C	-	-	-		
E _{rec}	Reverse recovery energy						mJ	
R _{thJC}	Thermal resistance, junction to case	per diode		-	-	1.5	K/W	
R _{thCH}	Thermal resistance, case to heatsink	per diode , $\lambda_{grease}= 1 \text{ W/(m} \cdot \text{K)}$		-	0.37	-	K/W	
T _{vjop}	Temperature under switching conditions			-40		150	°C	

Note:

IGBT electrical characteristics according to IEC 60747 – 9

Diode electrical characteristics according to IEC 60747 – 2

Module

Symbol	Item	Conditions	Rating			Unit
V _{ISOL}	Isolation voltage	Terminals to baseplate, RMS,f=50Hz,t=1min	2500			V
T _{vj} max	Maximum junction temperature	-	175			°C
T _{vj} op	Operating junction temperature	Continuous operationg(underswitching)	-40~ 150			°C
T _{stg}	Storage temperature	-	-40~ 125			°C
Symbol	Item	Conditions	Values			Unit
M	Mounting torque for module mounting	-	3	-	6	Nm
ds	Creepage distance	Terminal to terminal	-	-	-	mm
		Terminal to base plate	-	10	-	
da	Clearance	Terminal to terminal	-	-	-	mm
		Terminal to base plate	-	7.5	-	
m	Weight	-	-	290	-	g

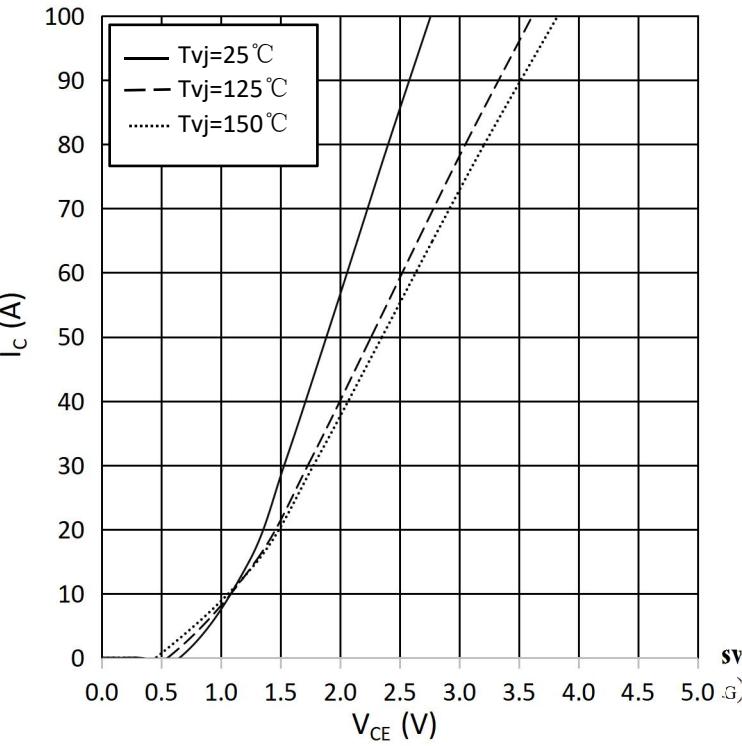
NTC Thermistor Characteristics

Symbol	Item	Conditions	Values			Unit
			Min.	Typ.	Max.	
R ₂₅	Rated resistance	T _C =25°C	-	5	-	kΩ
ΔR/R	Deviation of resistance	T _C = 100°C ,R ₁₀₀ =493Ω	-5	-	5	%
P ₂₅	Power dissipation	T _C =25°C	-	-	20	mW
B _{25/50}	B-constant	R ₂ =R ₂₅ exp[B _{25/50} (1/T ₂ - 1/(298. 15K))]	-	3375	-	K
B _{25/80}	B-constant	R ₂ =R ₂₅ exp[B _{25/80} (1/T ₂ - 1/(298. 15K))]	-	3411	-	
B _{25/100}	B-constant	R ₂ =R ₂₅ exp[B _{25/100} (1/T ₂ - 1/(298. 15K))]	-	3433	-	

output characteristic IGBT,Inverter (typical)

$I_C = f(V_{CE})$

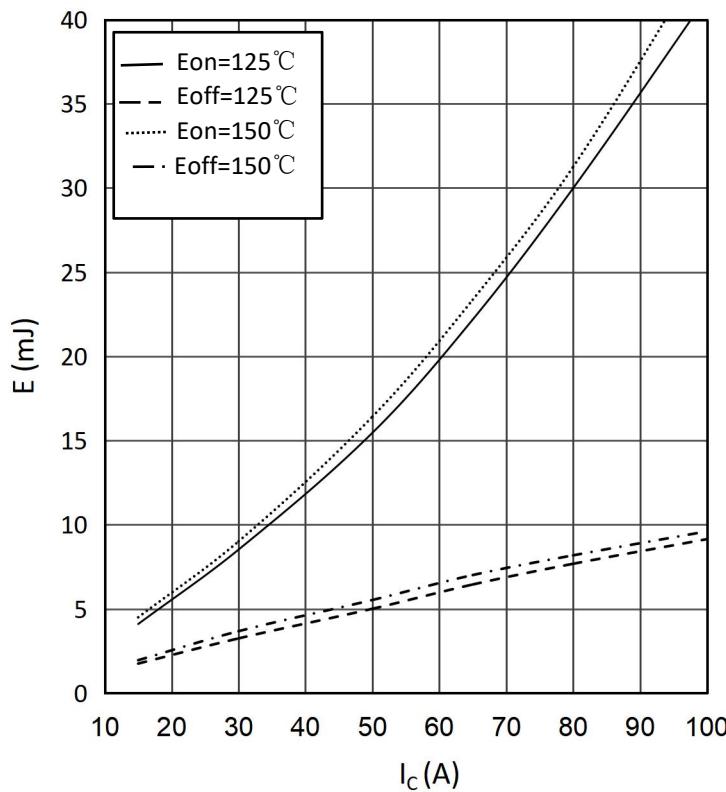
$V_{GE} = 15V$



switching losses IGBT,Inverter (typical)

$E_{on} = f(I_C)$, $E_{off} = f(I_C)$

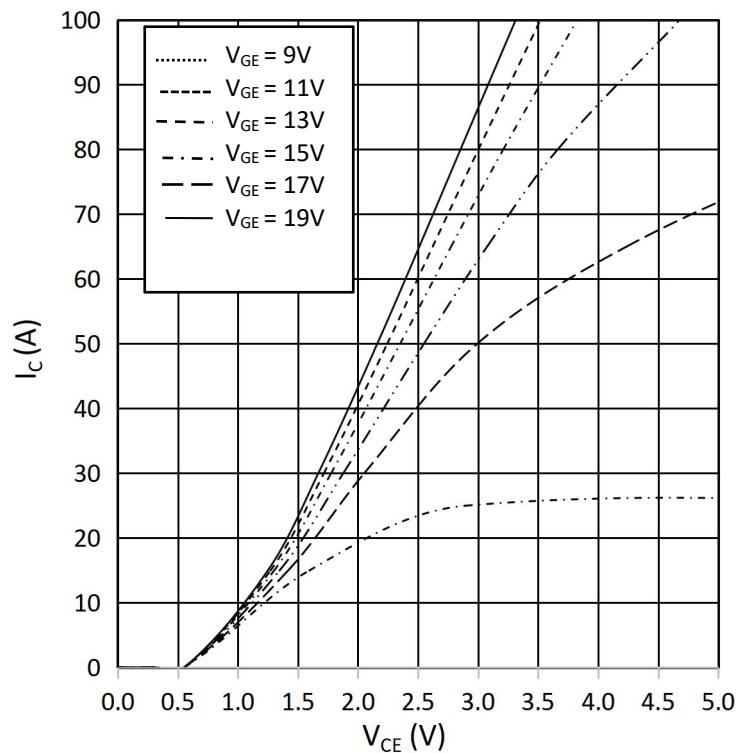
$V_{GE} = \pm 15V$, $R_{Gon} = 39\Omega$, $R_{Goff} = 39\Omega$, $V_{CE} = 600V$



output characteristic IGBT,Inverter (typical)

$I_C = f(V_{CE})$

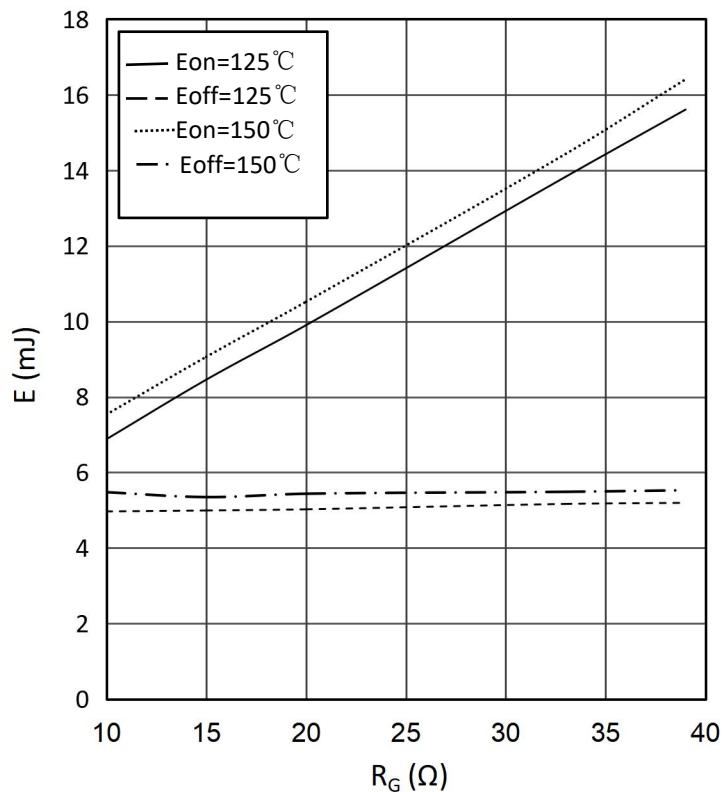
$T_{vj} = 150^{\circ}\text{C}$



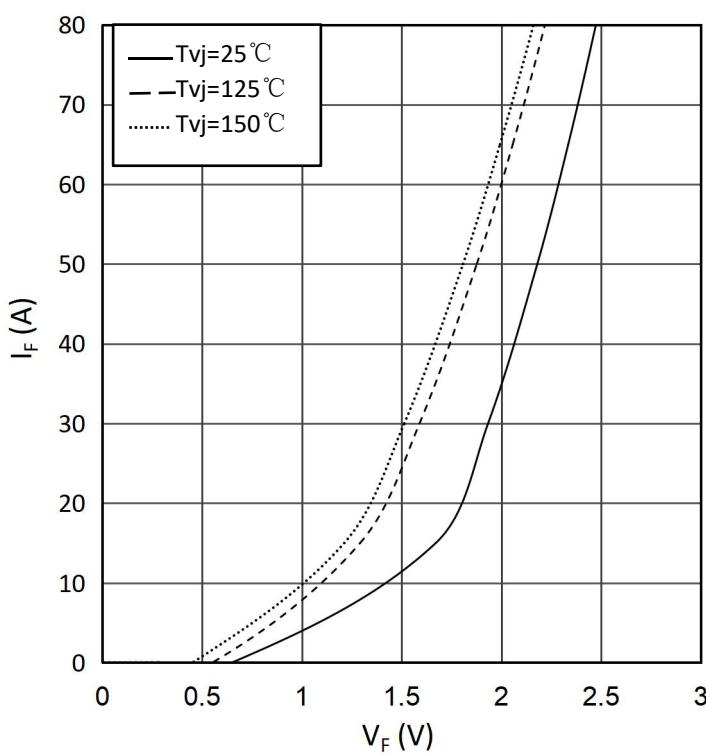
switching losses IGBT,Inverter (typical)

$E_{on} = f(R_G)$, $E_{off} = f(R_G)$

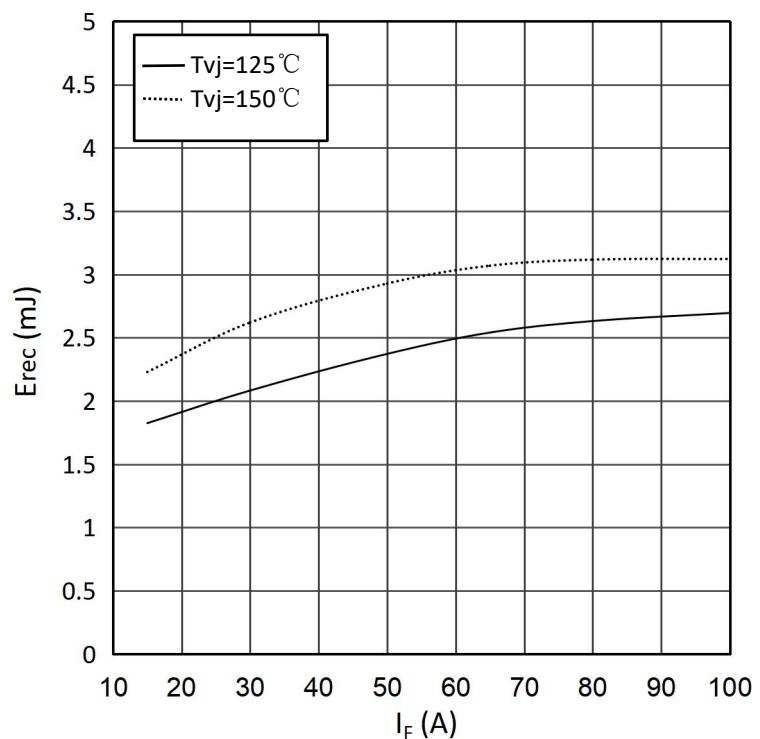
$V_{GE} = \pm 15V$, $I_C = 50A$, $V_{CE} = 600V$



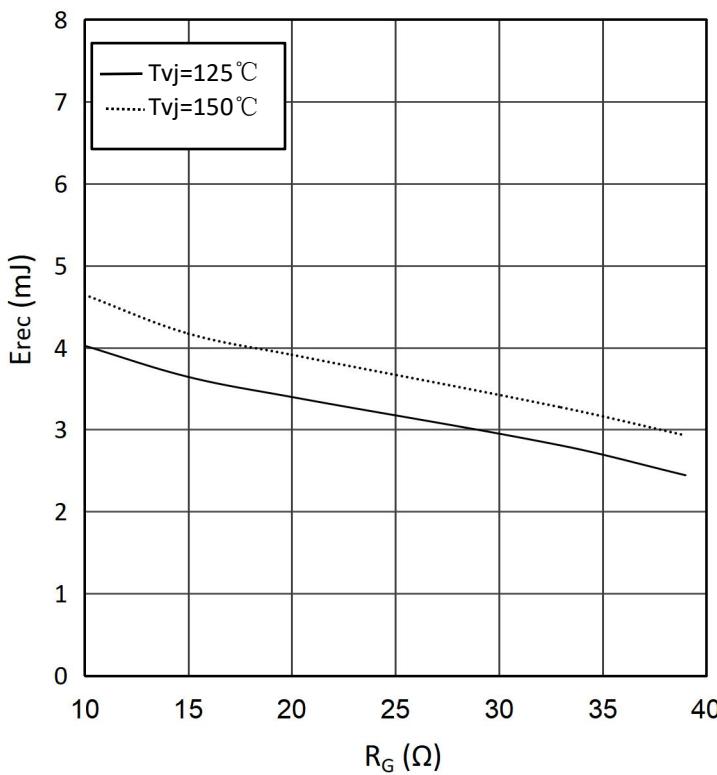
forward characteristic of Diode, Inverter (typical)
 $I_F = f(V_F)$



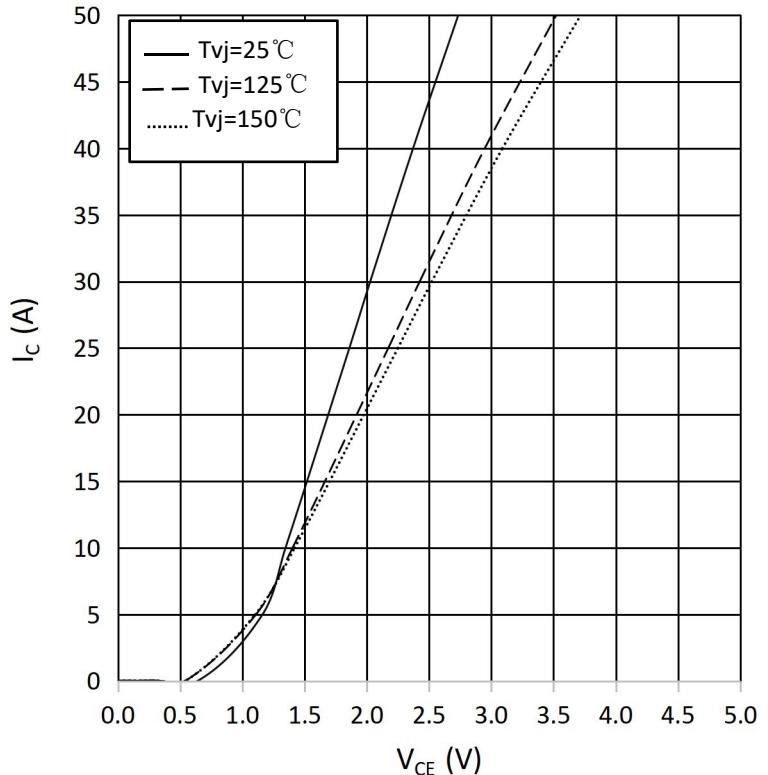
switching losses Diode, Inverter (typical)
 $E_{rec} = f(I_F)$
 $R_{Gon} = 39\Omega$, $V_{CE} = 600$ V



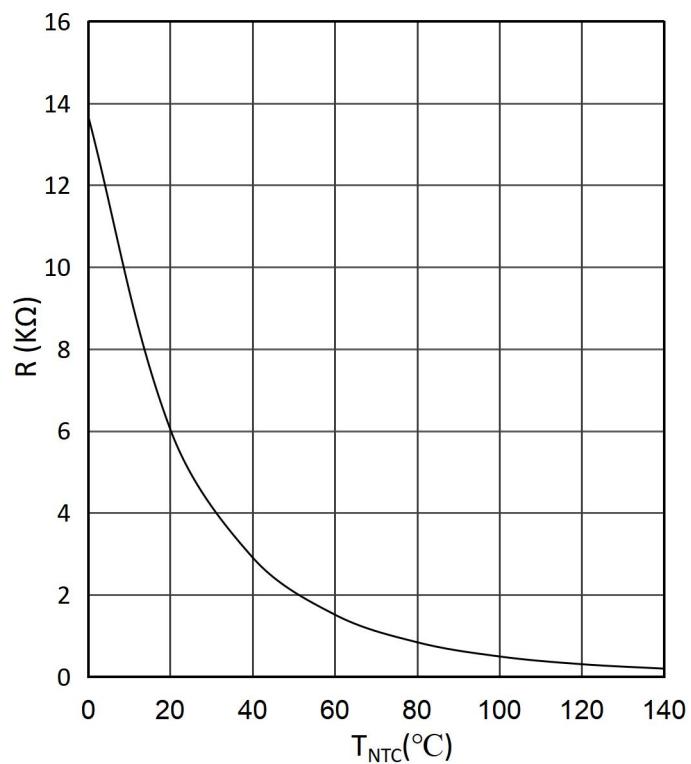
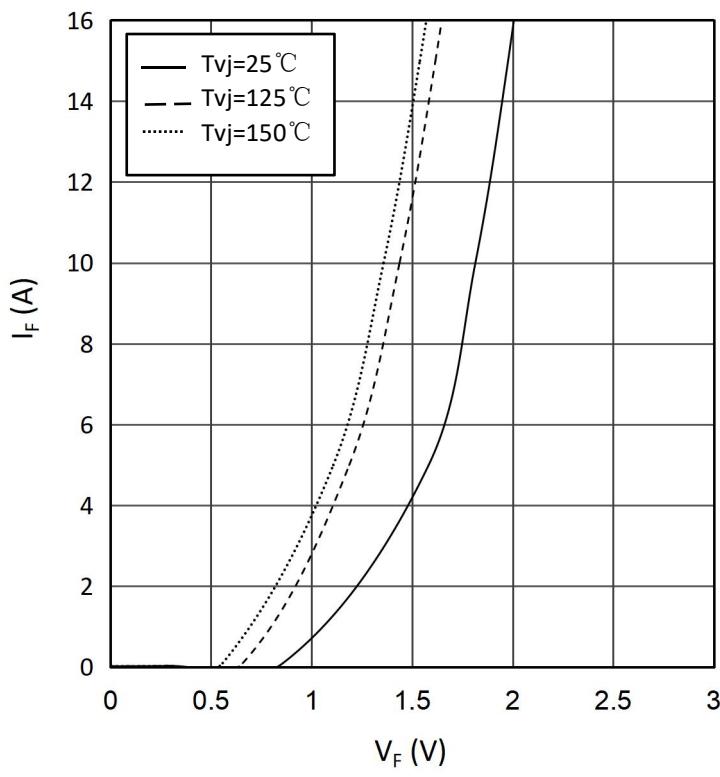
switching losses Diode, Inverter (typical)
 $E_{rec} = f(R_G)$
 $I_F = 50$ A, $V_{CE} = 600$ V



output characteristic IGBT, Brake-Chopper (typical)
 $I_C = f(V_{CE})$
 $V_{GE} = 15$ V

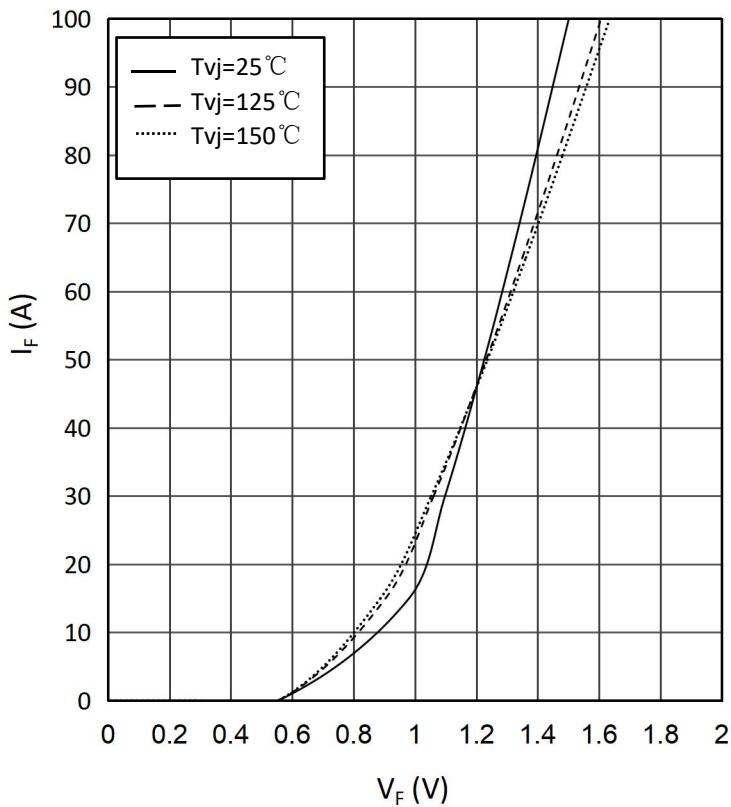


forward characteristic of Diode, Brake-Chopper (typical) $I_F = f(V_F)$ **NTC-Thermistor-temperature characteristic(typical)** $R=f(T)$

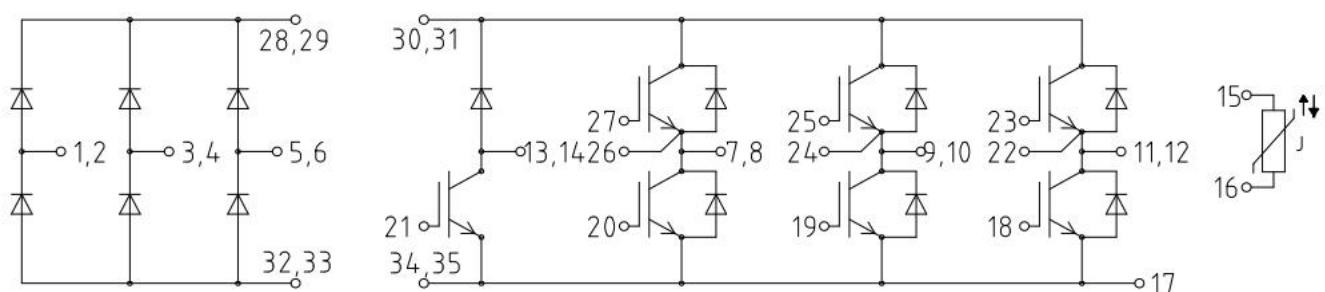


Forward characteristic of Diode,Rectifier(typical)

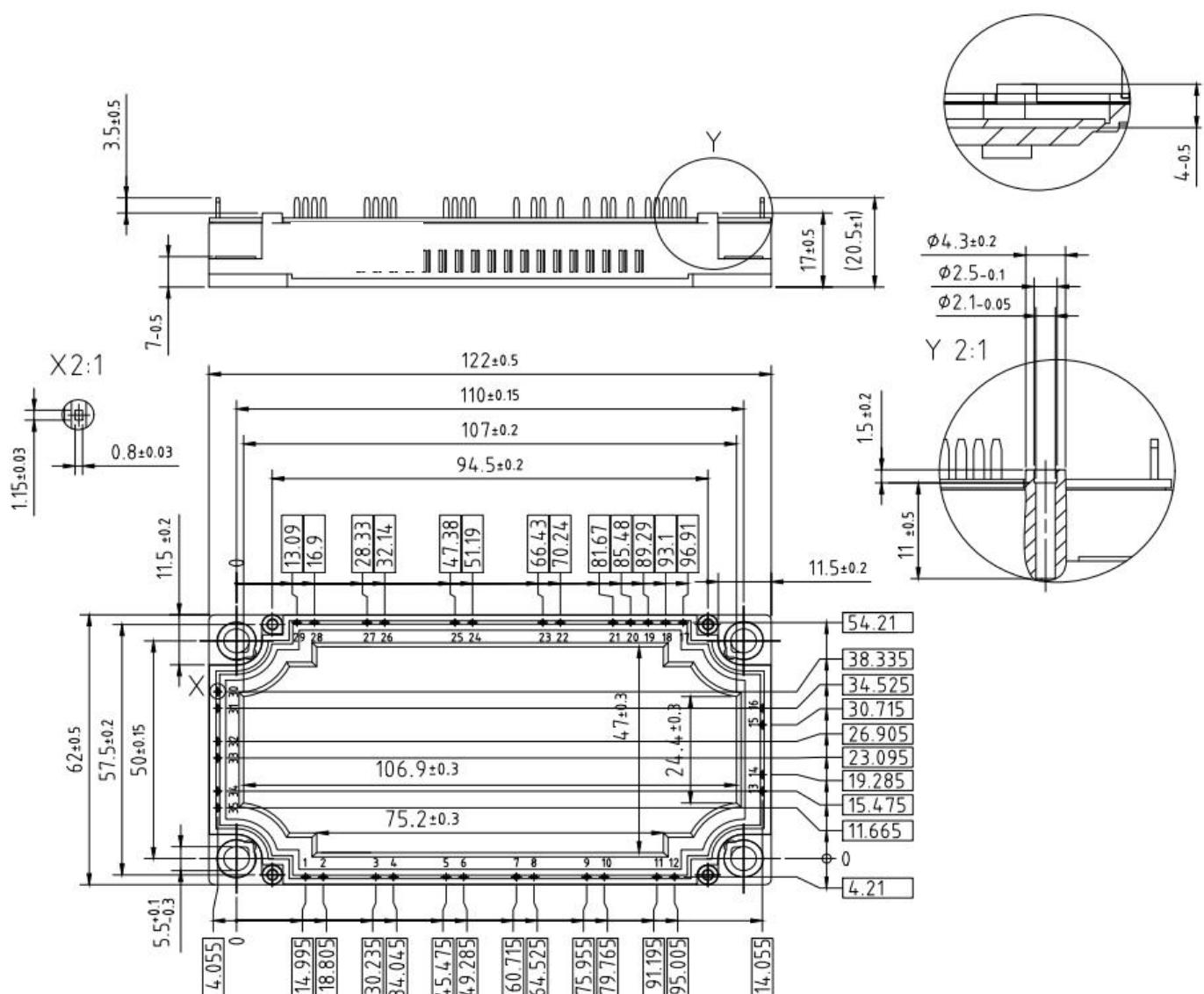
$$I_F = f(V_F)$$



Circuit Diagram



Package Outlines



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